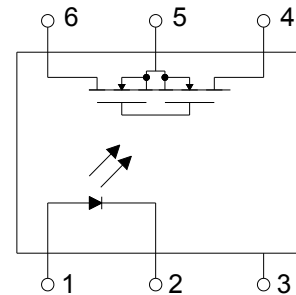


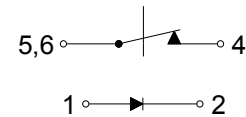
## ● Description

The KAQV414 series is robust, ideal for telecom and ground fault applications. It is a SPST normally close switch (1 Form B) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

## ● Schematic



1 FORM B  
NORMALLY CLOSE



## ● Features

1. Normally close, single pole single throw
2. Control 400V AC or DC voltage
3. Switch 130mA loads
4. Controls low-level analog signals
5. High sensitivity, low ON resistance
6. Low-level off-state leakage current
7. High isolation voltage
8. Pb free and RoHS compliant
9. Agency Approvals :
  - UL 508 / CUL C22.2 No.14-M91 , File No. E108430
  - FIMKO EN60950

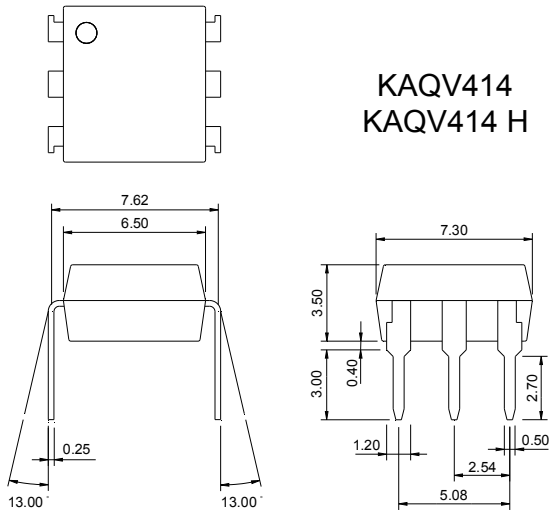
## ● Application

- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- Measuring and testing equipment
- Factory automation equipment
- High speed inspection machines

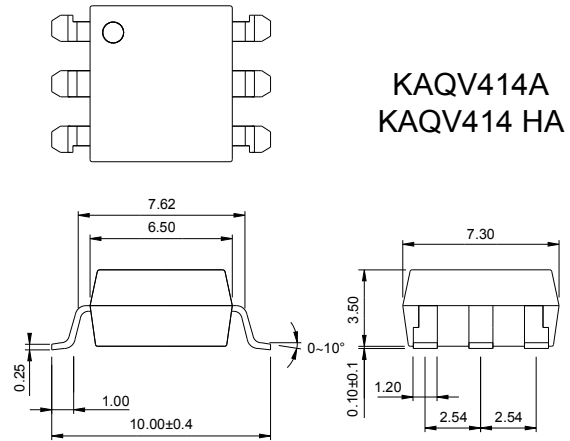
● **Outside Dimension**

Unit : mm

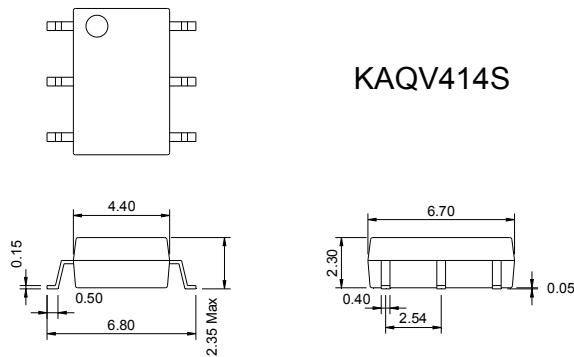
1. Dual-in-line type.



2. Surface mount type.

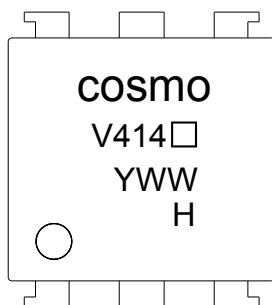


3. Small outline for surface mount type.



TOLERANCE : ±0.2mm

● **Device Marking**



**Notes :**

**COSMO**

V414□ □ : Pin forming

YWW Y : Year code / W : Week code

H High isolation voltage series only

**● Absolute Maximum Ratings**

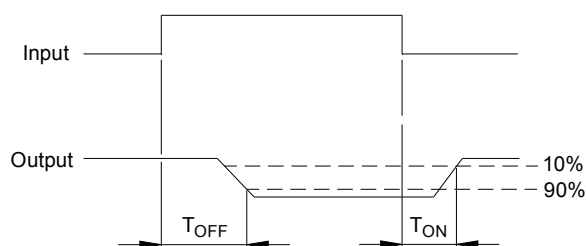
(Ta=25°C)

Item		Symbol	Rating		Unit
Input	Continuous forward current	$I_F$	50		mA
	Peak forward current	$I_{FP}$	1		A
	Reverse voltage	$V_R$	5		V
	Power dissipation	$P_{in}$	100		mW
	Derate linearly from 25°C	-	1.3		mW/°C
Output	Breakdown voltage	$V_B$	400		V
	Continuous load current	$I_L$	130		mA
	Power dissipation	$P_{out}$	500		mW
Isolation voltage		$V_{iso}$	<b>KAQV414S</b> 1500Vrms	<b>KAQV414</b> 3750Vrms	<b>KAQV414H</b> 5000Vrms
Isolation resistance (Vio=500V)		$R_{iso}$	$\geq 10^{10}$		$\Omega$
Total power dissipation		$P_t$	550		mW
Derate linearly from 25°C		-	2.5		mW/°C
Operating temperature		$T_{opr}$	-40 to +85		°C
Storage temperature		$T_{stg}$	-40 to +125		°C
Junction temperature		$T_j$	100		°C
Soldering temperature 10 seconds		$T_{sot}$	260		°C

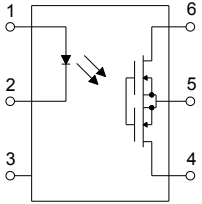
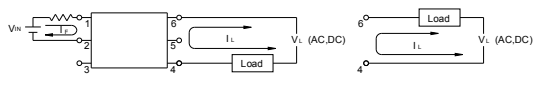
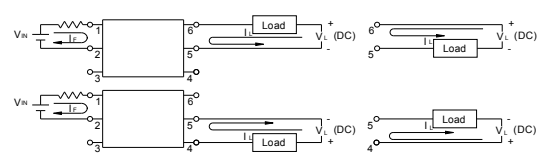
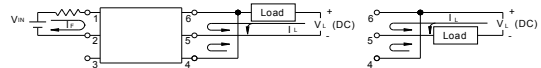
**● Electro-optical Characteristics**

(Ta=25°C)

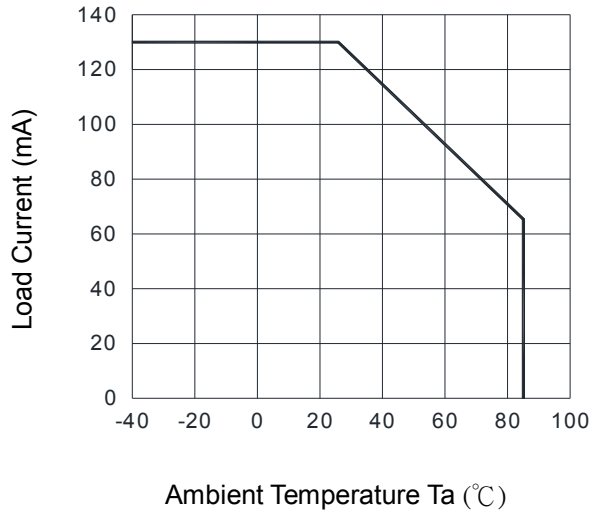
Parameter			Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage		$V_F$	$I_F=10\text{mA}$	-	1.2	1.5	V
	Operation input current		$I_{FOFF}$	$V_L=20\text{V}, I_L \leq 5\mu\text{A}$	-	-	3.0	mA
	Recovery input current		$I_{FON}$	$V_L=20\text{V}, I_L=100\text{mA}$	0.2	-	-	mA
Output	Breakdown voltage		$V_B$	$I_B=50\mu\text{A}, I_F=10\text{mA}$	400	-	-	V
	Off-state leakage current		$I_{LEAK}$	$V_L=100\text{V}, I_F=5\text{mA}$	-	1.0	2.0	$\mu\text{A}$
I/O capacitance			$C_{iso}$	$V_B=0\text{V}, f=1\text{MHz}$	-	6	-	pF
ON resistance	Connection	A	$R_{ON}$	$I_F=0\text{mA}, I_L=100\text{mA}$	-	25	50	$\Omega$
		B			-	13	25	
		C			-	7	12.5	
Reverse (ON) time			$T_{ON}$	$I_F=10\text{mA}, V_L=20\text{V}$	-	0.6	1.5	ms
Operate (OFF) time			$T_{OFF}$	$I_L=100\text{mA}, t=10\text{ms}$	-	0.3	1.0	ms

**● Turn-on / Turn-off Time**


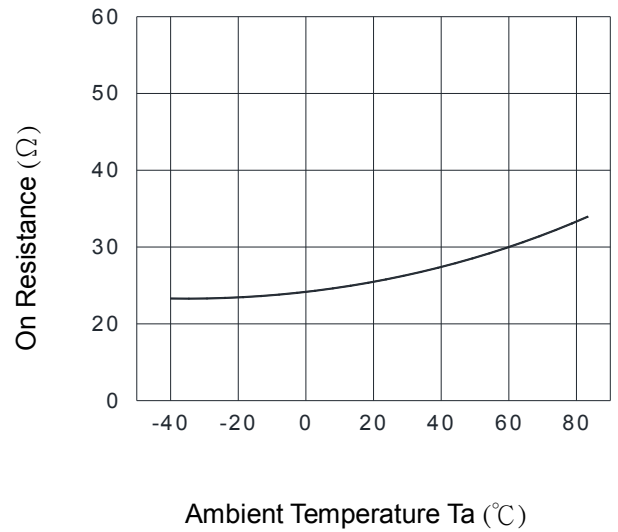
● Schematic and Wiring Diagrams

Schematic	Output Configuration	Load	Connection	Wiring Diagrams
	1b	AC DC	A	
		DC	B	
		DC	C	

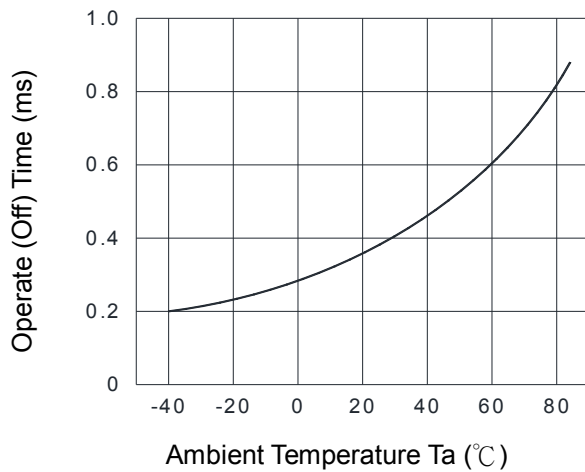
**Fig.1 Load Current vs. Ambient Temperature**



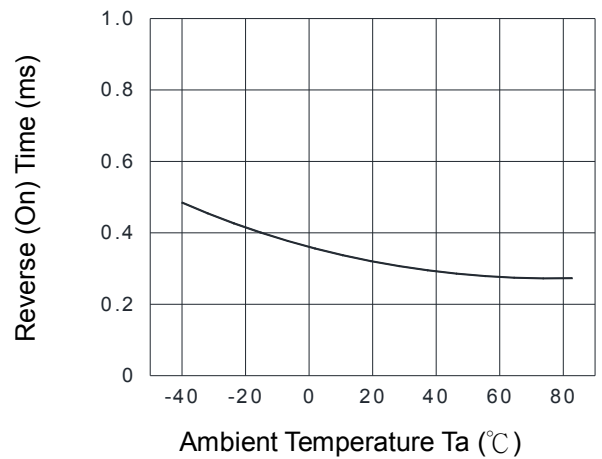
**Fig.2 On Resistance vs. Ambient Temperature**



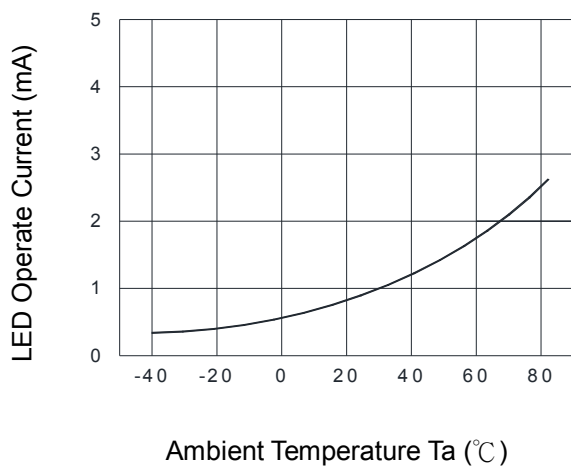
**Fig.3 Operate (OFF) Time vs. Ambient Temperature**



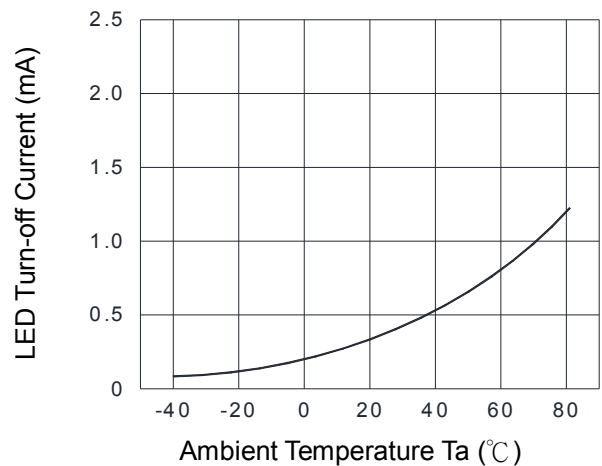
**Fig.4 Reverse (ON) Time vs. Ambient Temperature**



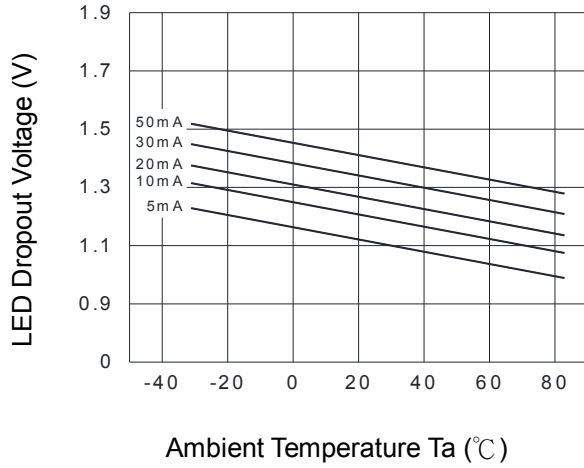
**Fig.5 LED Operate Current vs. Ambient Temperature**



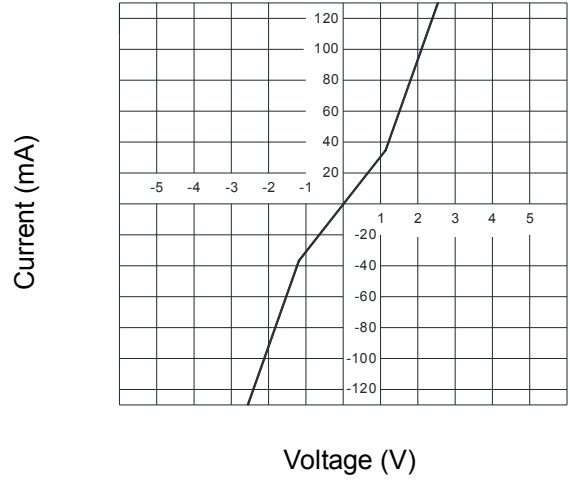
**Fig.6 LED Turn-off Current vs. Ambient Temperature**



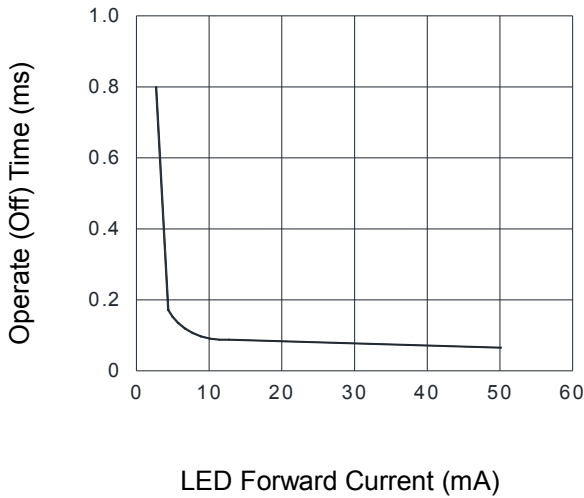
**Fig.7 LED Dropout Voltage vs. Ambient Temperature**



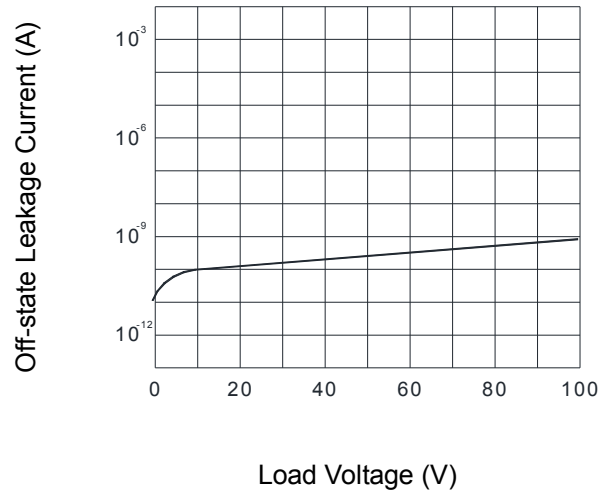
**Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion**



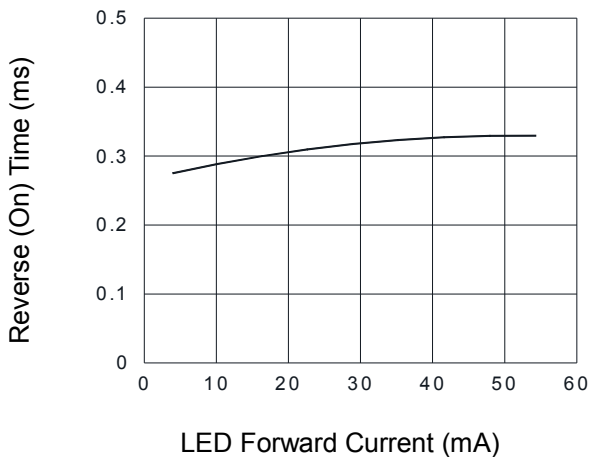
**Fig.9 Operate (OFF) Time vs. LED Forward Current**



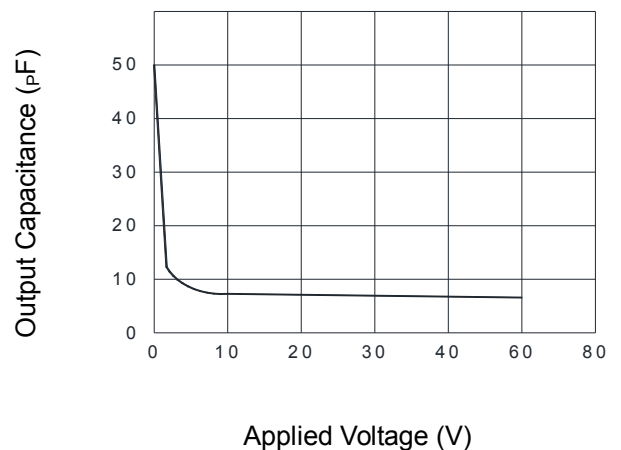
**Fig.10 Off-state Leakage Current vs. Load Voltage**



**Fig.11 Reverse (ON) Time vs. LED Forward Current**

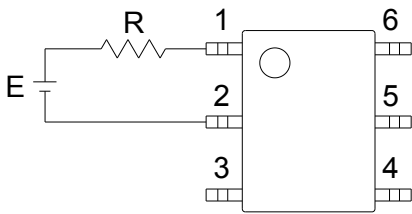


**Fig.12 Output Capacitance vs. Applied Voltage**



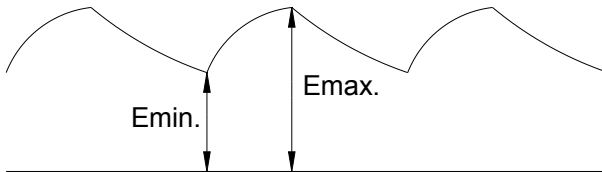
## ● Using Methods

Examples of resistance value to control LED forward current ( $I_f=5\text{mA}$ )

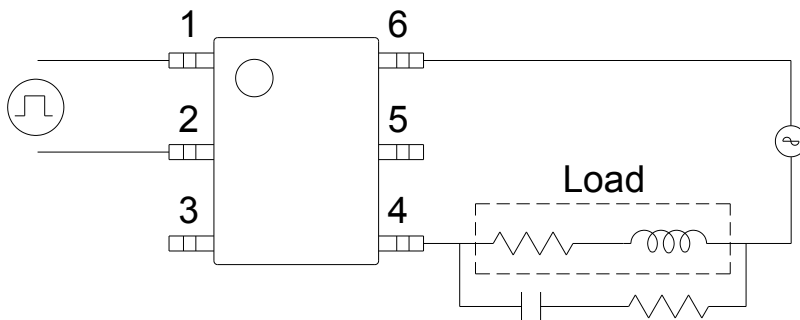
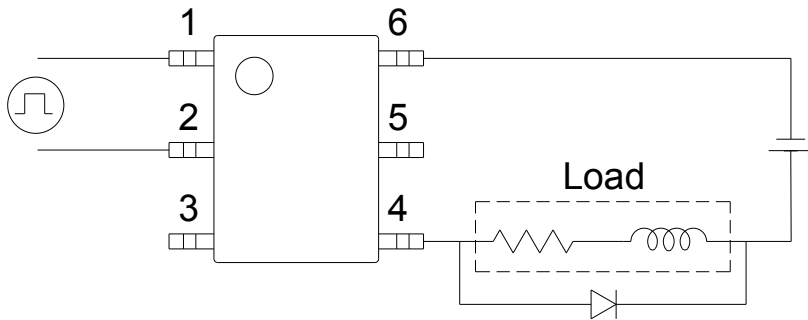


E	R
3.3V	Approx. 330 $\Omega$
5V	Approx. 640 $\Omega$
12V	Approx. 1.9K $\Omega$
15V	Approx. 2.5K $\Omega$
24V	Approx. 4.1K $\Omega$

1. LED forward current must be more than 5mA  $\cdot$  at E min.
2. LED forward current must be less than 50mA  $\cdot$  at E max.



Regulate the spike voltage generated on the inductive load as follows :



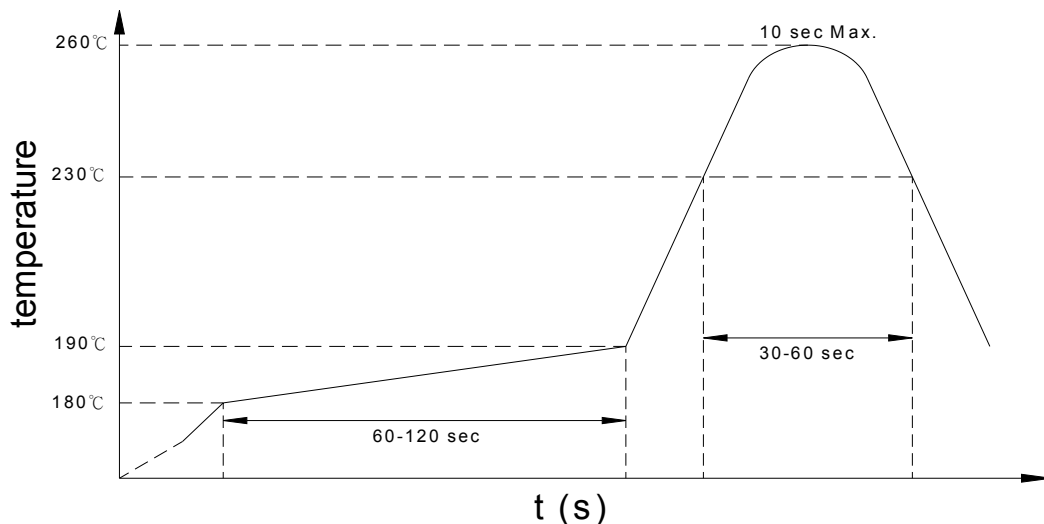
R-C Snubber

## ● Recommended Soldering Conditions

### (a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature: 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Number of reflows : Two
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



### (b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions: 120°C or below (package surface temperature)
- Number of times : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### (c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.



● **Numbering System**

**KAQV414 X (Y)**

**Note :**

KAQV414 = Part No.

X = Lead form option ( blank · S · A · H or HA )

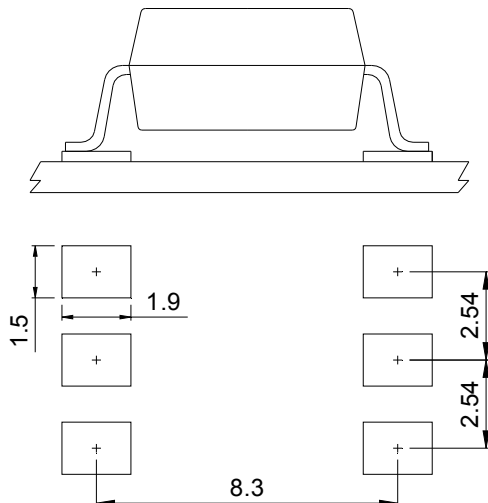
Y = Tape and reel option ( TL · TR )

Option	Description	Packing quantity
A (TL)	surface mount type package + TL tape & reel option	1000 units per reel
A (TR)	surface mount type package + TR tape & reel option	1000 units per reel
HA (TL)	surface mount type package + TL tape & reel option	1000 units per reel
HA (TR)	surface mount type package + TR tape & reel option	1000 units per reel
S (TL)	small outline for surface mount type package + TL tape & reel option	2000 units per reel
S (TR)	small outline for surface mount type package + TR tape & reel option	2000 units per reel

● **Recommended Pad Layout for Surface Mount Lead Form**

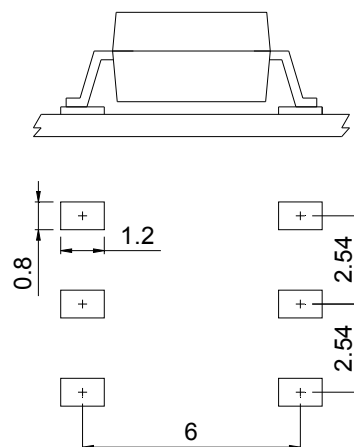
**1. Surface mount type.**

**6-pin SMD**



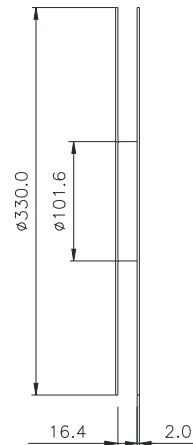
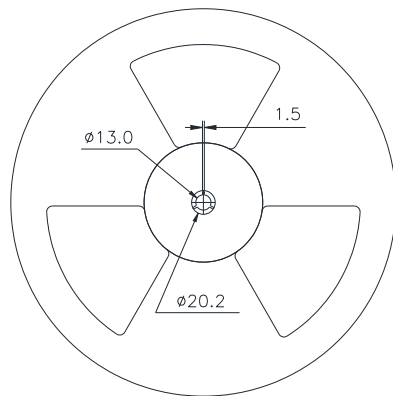
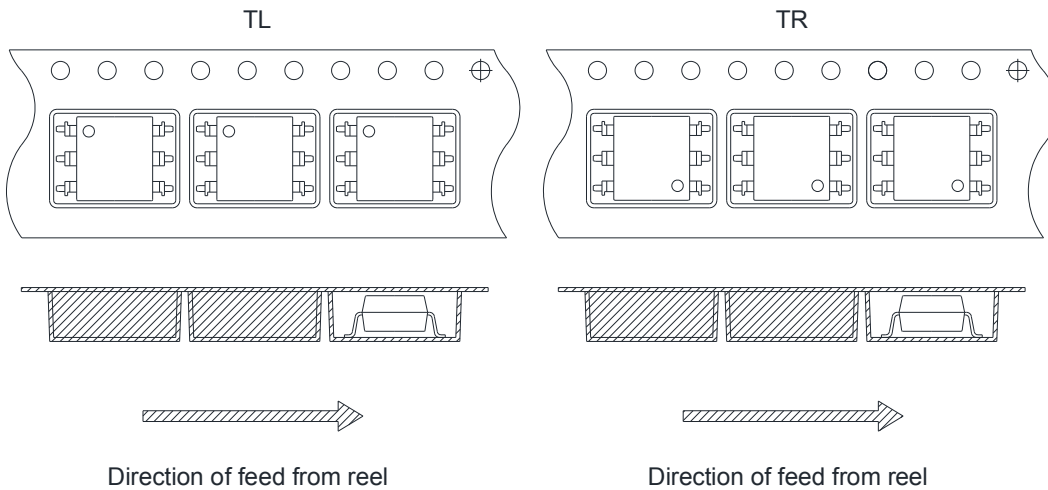
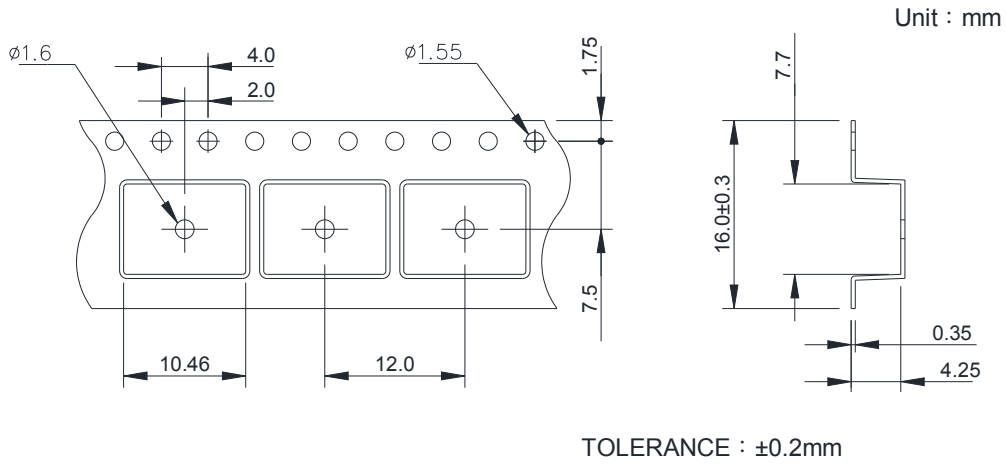
**2. Small outline for surface mount type.**

**6-pin SOP**



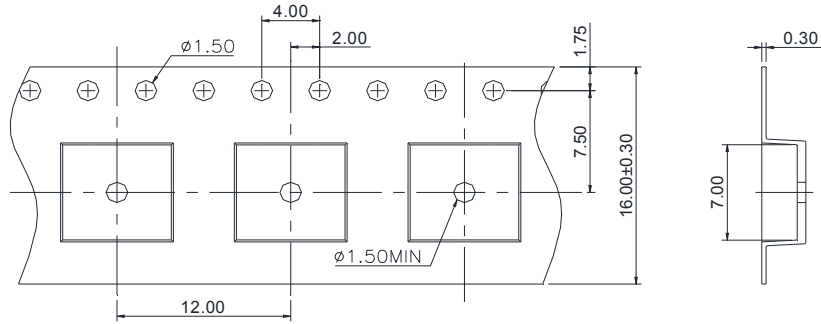
Unit : mm

● 6-pin SMD Carrier Tape & Reel



● 6-pin SOP Carrier Tape & Reel

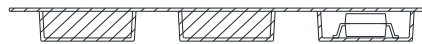
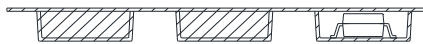
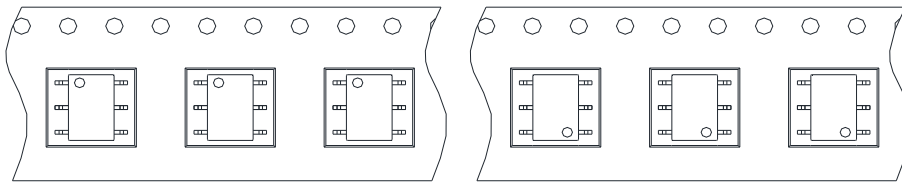
Unit : mm



TOLERANCE : ±0.2mm

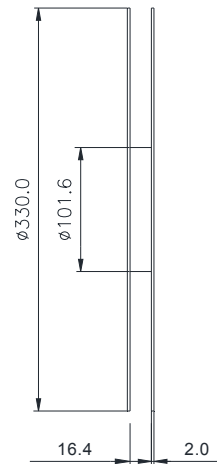
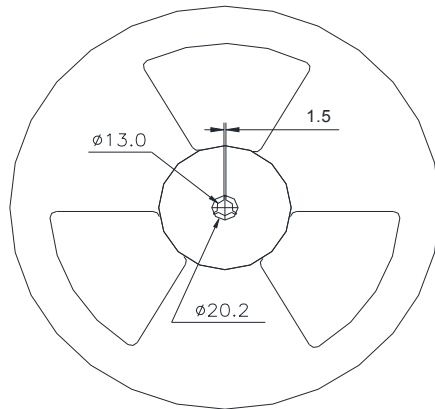
TL

TR



Direction of feed from reel

Direction of feed from reel





# KAQV414 Series

6PIN 400V N.C. TYPE  
SOLID STATE RELAY-MOSFET OUTPUT

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## ● Application Notice

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- d. Instrumentation
- e. Electrical application
- f. Measurement equipment
- g. Consumer electronics
- h. Telecommunication

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- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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